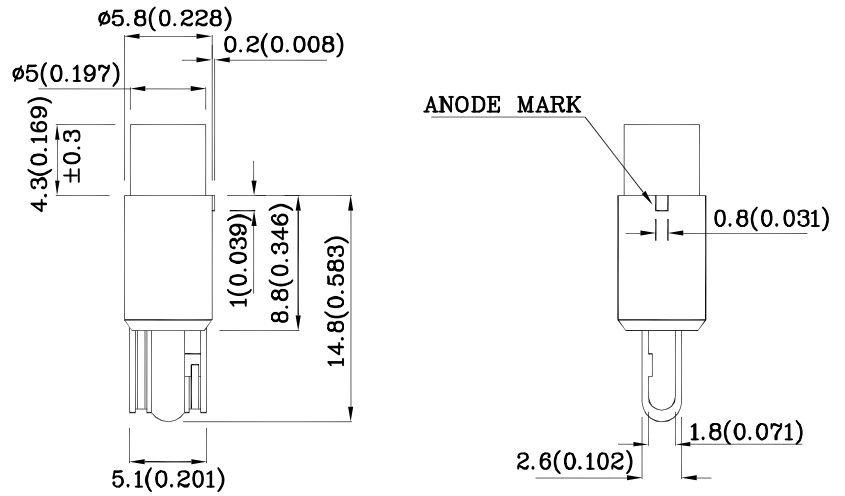


Features

- Housing material: Type 66 Nylon
- Housing UL rating: 94V-0
- Reliable & robust
- 5V internal resistor
- RoHS Compliant



Package Schematics



Notes:

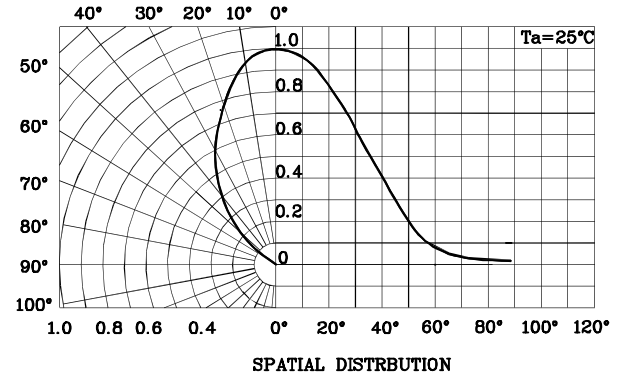
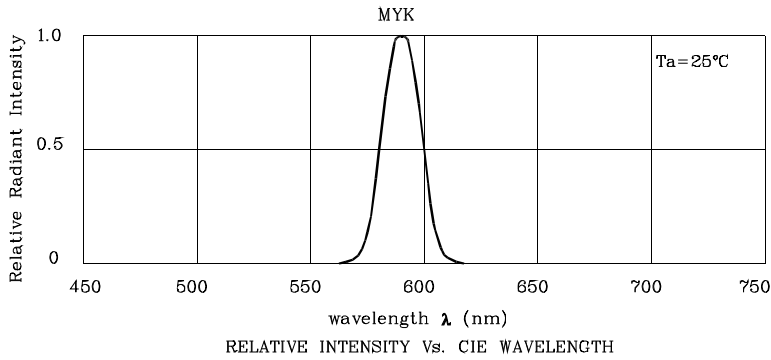
1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.25(0.01)$ unless otherwise noted.
3. Specifications are subject to change without notice.

Absolute Maximum Ratings ($T_A=25^\circ\text{C}$)		MYK (AlGaInP)	Unit
Reverse Voltage	V_R	5	V
Forward Voltage	V_F	6	V
Power Dissipation	P_D	85	mW
Operating Temperature	T_A	-40 ~ +70	°C
Storage Temperature	T_{stg}	-40 ~ +85	
Lead Solder Temperature [2mm Below Package Base]	260°C For 3 Seconds		
Lead Solder Temperature [5mm Below Package Base]	260°C For 5 Seconds		

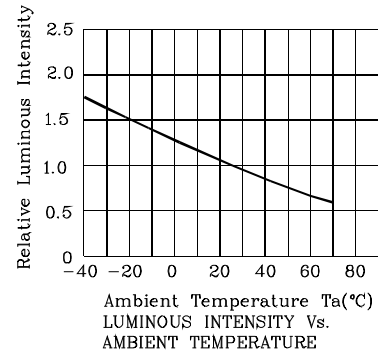
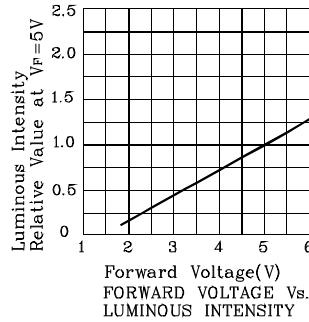
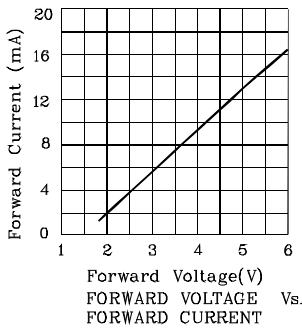
Operating Characteristics ($T_A=25^\circ\text{C}$)		MYK (AlGaInP)	Unit
Forward Current (Typ.) ($V_F=5\text{V}$)	I_F	13	mA
Forward Current (Max.) ($V_F=5\text{V}$)	I_F	17.5	mA
Reverse Current (Max.) ($V_R=5\text{V}$)	I_R	10	uA
Wavelength of Peak Emission CIE127-2007*(Typ.) ($V_F=5\text{V}$)	λ_P	590*	nm
Wavelength of Dominant Emission CIE127-2007*(Typ.) ($V_F=5\text{V}$)	λ_D	590*	nm
Spectral Line Full Width At Half-Maximum (Typ.) ($V_F=5\text{V}$)	$\Delta\lambda$	20	nm

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity CIE127-2007* ($V_F=5\text{V}$) mcd		Wavelength CIE127-2007* λ_P nm	Viewing Angle 2 θ 1/2
				min.	typ.		
XNZSMYK52W5V02	Yellow	AlGaInP	Water Clear	30*	80*	590*	70°

*Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.



❖ MYK



Wave Soldering Profile For Thru-Hole Products (Pb-Free Components)



Notes:

1. Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 280°C
2. Peak wave soldering temperature between 245°C ~ 255°C for 3 sec (5 sec max).
3. Do not apply stress to the epoxy resin while the temperature is above 85°C.
4. Fixtures should not incur stress on the component when mounting and during soldering process.
5. SAC 305 solder alloy is recommended.
6. No more than one wave soldering pass.

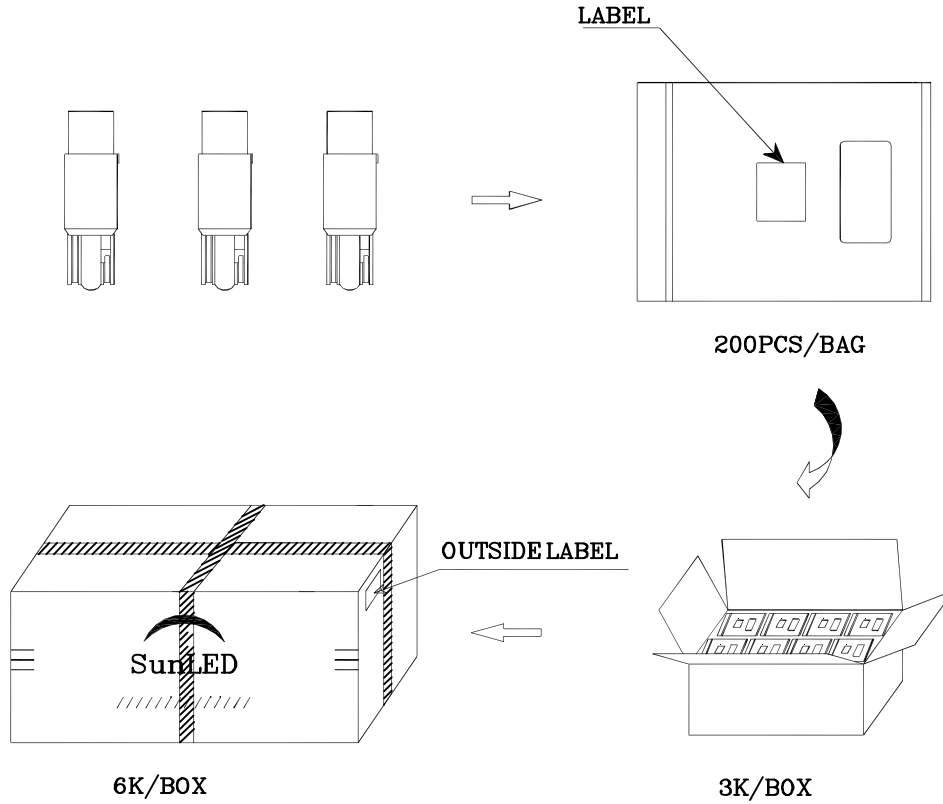

Remarks:

If special sorting is required (e.g. binning based on Luminous intensity/ luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:


1. Wavelength: +/-1nm
2. Luminous intensity/ luminous flux: +/-15%

Note: Accuracy may depend on the sorting parameters.

PACKING & LABEL SPECIFICATIONS

Q.C
 Q C
 XX XX XXXX
 PASSED

P/N0 : XNZSxxx52xx02	
QTY : 200 pcs	CODE: XXX
S/N : XX	
LOT NO:	
 XXXXXXXXXXXXXXXXXXXXXXXX	
RoHS Compliant	